CEC1302

CEC1302 ROM Description Addendum

INTRODUCTION

This document describes the functionality provided by the ROM code in the CEC1302.

This document includes the following topics:

- CEC1302 ROM Design on page 4
- Selection of SPI Port on page 4
- SPI Load of Firmware on page 5
- Load Failures on page 9
- ROM Event Log on page 9
- SHA-256 Hashing and Data Order on page 11
- ROM Runtime API on page 15

Audience

This document is written for developers.

References

The following documents should be referenced when using this addendum. See your Microchip representative for availability.

- CEC1302 Data Sheet
- CEC1302 Crypto API User's Guide
- CEC1302 Peripheral API User's Guide
- CEC1302 CLIB/PLIB Releases

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1.0 CONVENTIONS

The first table defines common terminology used in the documentation. The second table defines the register bit access type notation used in the documentation. These are the access types that are supported.

Term	Definition
Block	Used to identify or describe the logic or IP Blocks implemented in the device.
Reserved	Reserved registers and bits defined in the following table are read only values that return 0 when read. Writes to these reserved registers have no effect.
Test	Test locations should not be modified from their default value. Changing a Test register may cause unwanted results. Unless otherwise specified, a Test bit field, when written, should be written with its current value.
b	The letter ‘b’ following a number denotes a binary number.
h	The letter ‘h’ following a number denotes a hexadecimal number.

Register access notation is in the form “Read / Write”. A Read term without a Write term means that the bit is read-only and writing has no effect. A Write term without a Read term means that the bit is write-only, and assumes that reading returns all zeros.

Register Bit Type Notation	Register Bit Description
R	**Read:** A register or bit with this attribute can be read.
W	**Write:** A register or bit with this attribute can be written.
RS	**Read to Set:** This bit is set on read.
RC	**Read to Clear:** Content is cleared after the read. Writes have no effect.
WC	**Write One to Clear:** writing a one clears the value. Writing a zero has no effect.
WZC	**Write Zero to Clear:** writing a zero clears the value. Writing a one has no effect.
WS	**Write One to Set:** writing a one sets the value to 1. Writing a zero has no effect.
WZS	**Write Zero to Set:** writing a zero sets the value to 1. Writing a one has no effect.

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2.0 CEC1302 ROM DESIGN

The CEC1302 ROM's purpose is to load application EC firmware from an external SPI flash device into internal SRAM, verify its authenticity and launch the application firmware. In addition, the ROM includes a set of APIs for loading firmware from the SPI flash device into SRAM at runtime and cryptographic operations.

The CEC1302 includes two master-only General Purpose SPI controllers. Each SPI port has two dedicated chip select pins, implemented with GPIOs. The controller is capable of half duplex (single bi-directional pin), full duplex (one transmit and one receive pin) and double input data rate (transmit pin becomes second receive pin during data reception phase).

The ROM EC firmware loader will support SPI frequencies of [48, 24, 16, 12] MHz. The runtime API will allow application firmware to use the GP-SPI controllers at any of the four supported frequencies.

The GP-SPI controller allows configuration of both transmit and receive clock edge sampling. The ROM application firmware loader function will use Mode 00, in which both transmit and receive data occur on rising clock edges.

2.1 ROM Startup on Reset

On VCC1 power-on reset, the EC will perform the following functions:

1. Basic configuration of device:
   a) Disable interrupts in the EC (except NMI and Hard Error)
   b) Enable the EC FPU
   c) Set EC clock frequency to maximum (48MHz)
2. Execute C startup code
   a) Setup stack
   b) Load non-zero global variable values from table
   c) Call C main() function
3. C main() processing
   a) Clear EC Subsystem AHB Error register.
   b) Route interrupts to NVIC.
   c) Enable 16-bit Basic Timer 0 for 10 us tick time, count down, and no interrupt.
   d) Power on DMA block.
4. Select the SPI port for loading. See **Section 2.2 “Selection of SPI Port”**
5. SPI Load of Application Firmware. See **Section 3.0 “SPI Load of Firmware”**

2.2 Selection of SPI Port

The Boot ROM power-on firmware attempts to boot the EC using data from either a private SPI Flash device attached to SPI Controller 1, or from the public SPI Flash attached to SPI Controller 0 and shared with the Host core logic.

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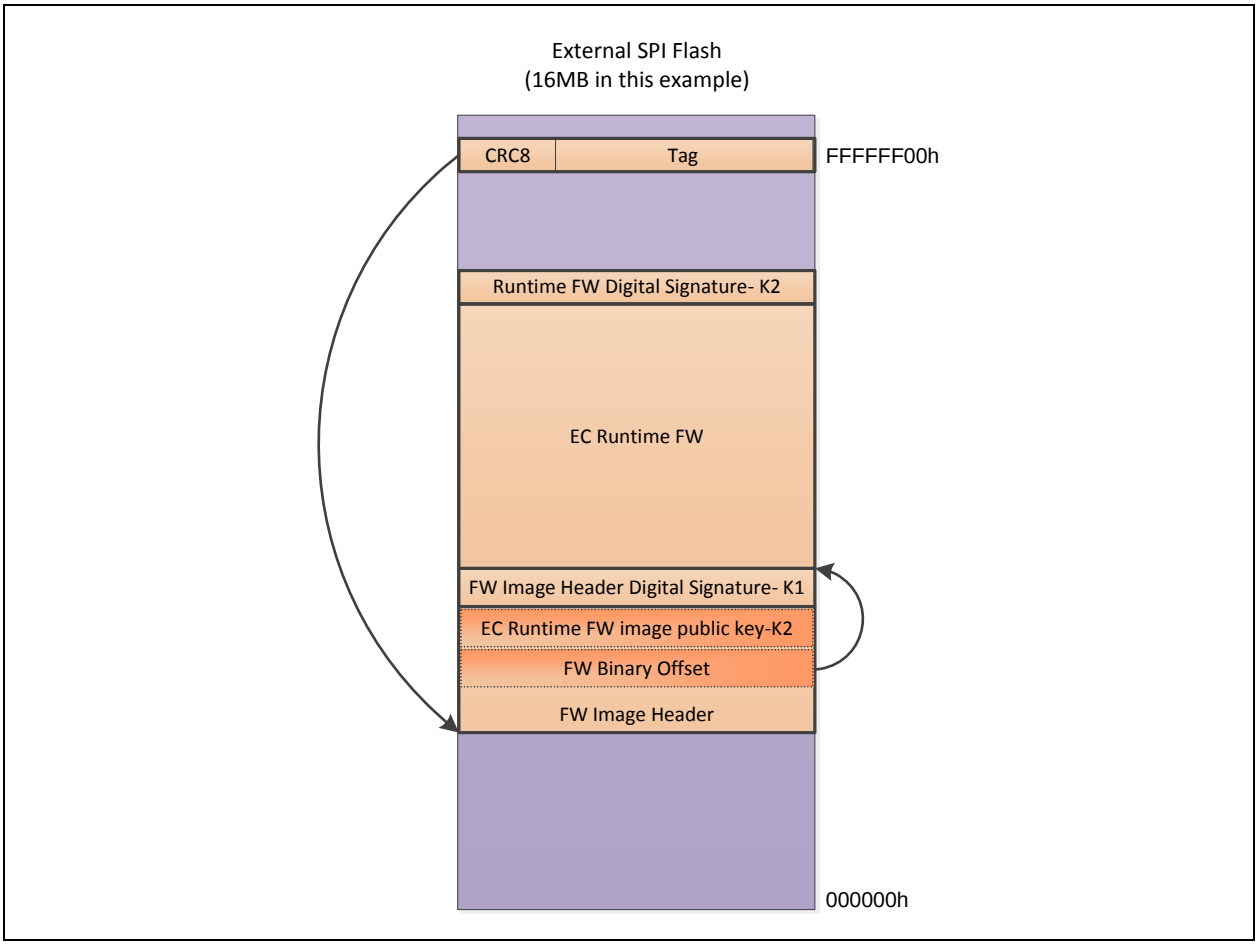
3.0 SPI LOAD OF FIRMWARE

In order to boot the EC from an external SPI Flash, the Boot ROM firmware can access several regions in the SPI Flash:

1. A 4-byte Tag that identifies the position of the FW Image Header in the Flash
2. A 320-byte FW Image Header
3. A 256-byte DER encoded PKCS#1 v1.5 Signature of the FW Image Header
4. The EC Runtime FW body, which is an integral multiple of 64 bytes
5. A 256-byte DER encoded PKCS#1 v1.5 Signature of the EC Runtime FW

The following figure illustrates the layout of the regions in an example SPI Flash:

FIGURE 3-1: SPI FLASH REGION LAYOUT EXAMPLE



The regions are described in more detail in the next sections.

The SPI Load operation proceeds as follows:

1. Wait for the Chip Select 0 input for the shared SPI controller (SHD_CS0#) to be high. Since the Chip Select should be pulled high to the power rail that powers the SPI Flash devices, the EC uses this test to verify that the SPI Flash devices have power.
2. Examine the Private SPI Chip Select (PVT_CS0#). This is used as strap to determine if there is a Private SPI Flash in the system. If PVT_CS0# is high, then the following step is executed:
   a) Configure the private SPI Controller for 12MHz operation and execute the Load Sequence targeting the Private SPI Flash
3. If the Load Sequence on the Private SPI Flash fails, or the strap option indicates that there is no Private SPI Flash, and RSMRST# is asserted, configure the private SPI Controller for 12MHz operation and execute the Load Sequence on the Shared SPI Flash.

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4. If the Load Sequence on the Shared SPI Flash fails the ROM code quits

The Shared SPI Bus will only be checked if RSMRST# is active Low. If RSMRST# is high then the chipset owns the shared SPI bus and the EC must keep its shared SPI signals tri-stated.

The Load Sequence attempts to load a valid firmware image in the SRAM and then execute it.

The ROM tries to locate a valid image in up to 4 locations. The locations are searched in the following order:

1. Private SPI Controller, Tag located at 0xFFFFFF00 in the SPI Flash, Chip Select 0,
2. Private SPI Controller, Tag located at 0xFFFFFF04 in the SPI Flash, Chip Select 0.
3. Shared SPI Controller, Tag located at 0xFFFFFF00 in the SPI Flash, Chip Select 0,
4. Shared SPI Controller, Tag located at 0xFFFFFF04 in the SPI Flash, Chip Select 0.

The read of the Tag section is suppressed and the load fails if the Tag section is not valid. The Tag is considered valid if:

1. The CRC in the Tag is correctly generated

Once a location in the SPI Flash is selected, the Load Sequence loads the Firmware Image Header. The validity of the header is checked once it is loaded, and if the validity check fails, no further reads from the SPI Flash are performed and the load fails. The Firmware Image Header is valid if:

1. The first 4 bytes of the header are "SMSC"
2. The SPI speed and SPI read command are valid
3. The Load Address, Payload Length and Payload entry point are all valid with respect to the SRAM

If the Header is valid, the ROM code proceeds to copy the EC Runtime Binary Image from the SPI Flash into SRAM. The validity of the Binary Image is checked once it is loaded, and if the validity check fails, the load fails. The EC Runtime Binary Image is valid if:

1. The signature of the FW Image Header was correctly signed by the customer
2. The EC Runtime FW Binary Image was correctly signed using the public key contained in the FW Image Header

Once a validated EC Runtime FW Binary Image is loaded into SRAM, the ROM code exits the ROM by:

1. Clearing all SRAM used by Boot ROM functions, including the Cryptographic RAM
2. Leaving the SPI controllers in their power-on default state
3. Jumping to an entry point in the SRAM defined by the Header

3.1 Tag

The Tag consists of 32-bits that contain a pointer to the EC code image and its header. The Load Sequence first checks for a tag at offset 0xFFFFFF00 (256 bytes below the last location in the flash) in the SPI flash chip connected to the currently selected SPI controller, using Chip Select 0. If the data stored at offset 0xFFFFFF00 fail the Tag validation, the FW Image Header validation, or the EC Runtime FW Binary Image validation, the Load Sequence then checks for a valid tag at offset 0xFFFFFF04. If the second validation also fails, the ROM code concludes that there is not a valid EC Runtime FW Binary Image in the SPI Flash.

The format of the Tag is:

1. Tag Bits [22:0] correspond to bits [30:8] of the address in the SPI flash device. The Header is therefore always located on a 256 byte boundary in the SPI Flash
2. Tag Bit [23] indicates the SPI chip select.

   0b = chip select 0,
   1b = chip select 1.

   This means the Header and EC binary can be located in a different SPI Flash part than the Tag.
3. Tag Bits [31:24] contain a CRC8 checksum of bits [23:0] of the Tag. The CRC uses CRC8-ITU. If the CRC check fails the tag is considered invalid.

The Tag is read at a SPI Flash data rate of 12MHz, using the standard Read command 0x3.

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3.2 Firmware Image Header

The FW Image Header is located in a SPI Flash device selected by CS0# or CS1#, as determined by the Tag, on the selected SPI controller. The Header is located at an offset in the SPI Flash that is on a 256-byte boundary. The Header is read at a SPI Flash data rate of 12MHz, using the standard Normal Read command 0x3.

The FW Image Header is validated by calculating a SHA-256 Hash on the header (offsets 0x0 through 0x13F), decrypting the 256-byte Signature located at offset 0x140, and verifying that the calculated hash and the hash that was encrypted in the Signature match.

The following tables define the format of the Firmware Image Header:

TABLE 3-1: FIRMWARE IMAGE HEADER FORMAT

Byte Offset	Definition	Comment
0x00	ASCII ‘C’	0x43
0x01	ASCII ‘S’	0x53
0x02	ASCII ‘M’	0x4D
0x03	ASCII ‘S’	0x53
0x04	Header Version	0x00
0x05	Reserved	Must be 0
0x06	Bits[1:0] SPI Clock Speed	0 = 48 MHz 1 = 24 MHz 2 = 16 MHz 3 = 12 MHz
	Bits[7:2]	Must be 0
0x07	Flash Read Command	See Table 3-2, "Flash Read Command Options"
0x08 to 0x0B	Load Address b[31:0] Little-Endian: Offset 0x08 = b[7:0] Offset 0x09 = b[15:8] Offset 0x0A = b[23:16] Offset 0x0B = b[31:24]	Start address in SRAM where the EC Firmware Image will be loaded.
0x0C to 0x0F	Entry Address b[31:0] Little-Endian: Offset 0x0C = b[7:0] Offset 0x0D = b[15:8] Offset 0x0E = b[23:16] Offset 0x0F = b[31:24]	EC Firmware Entry Point. ROM jumps to this address on successful load and verify.
0x10 to 0x11	FW Binary Length Little-Endian: Offset 0x10 = b[7:0] Offset 0x11 = b[15:8]	Units of 64 bytes
0x12 to 0x13	Reserved	Must be 0
0x14 to 0x17	FW Binary SPI Location Offset 0x14 = b[7:0] Offset 0x15 = b[15:8] Offset 0x16 = b[23:16] Offset 0x17 = b[31:24] Bits[5:0] must be 0	Unsigned offset in bytes from beginning of header in SPI of the FW payload. FW Payload is the code image plus signature. The offset must be evenly divisible by 64. Stored little-Endian.
0x18 to 0x1F	Reserved	Must be 0
0x20 to 0x27	RSA Public Key 2 Exponent Offset[23:20] = b[31:0] Offset[27:24] = b[63:32]	RSA Public Key Exponent of PK2. NOTE: Exponent length is 8 bytes (64 bits). Stored little-endian.
0x28 to 0x2F	Reserved	Must be 0

TABLE 3-1: FIRMWARE IMAGE HEADER FORMAT (CONTINUED)

Byte Offset	Definition	Comment
0x30 to 0x12F	RSA Public Key 2 Modulus Offset[33:30] = b[31:0] Offset[37:34] = b[63:32] Offset[3B:38] = b[95:64] … Offset[12F:12C] = b[2047:2016]	RSA Public Key Modulus of PK2. NOTE: Modulus length is 256 bytes (2048 bits). Stored Little-Endian.
0x130 to 0x13F	Reserved	Must be 0
0x140 to 0x23F	Signature Offset[143:140] = b[31:0] Offset[147:144] = b[63:32] Offset[14B:148] = b[95:64] … Offset[23F:23C] = b[2047:2016]	256-byte signature of Header, encrypted with a 2048-bit Private key. It is stored Little-Endian.

TABLE 3-2: FLASH READ COMMAND OPTIONS

Command	SPI Read Command	Description
0	0x03	Normal Read
1	0x0B	Fast Read
2	0x3B	Fast read with double data rate return
>2	Reserved	

3.3 FW Image Header Digital Signature – K1

The FW Image Header Digital Signature is a DER encoded PKCS#1 v1.5 digital signature. The signature comprises a 256-bit SHA256 hash of the 320 byte FW Image Header, encrypted using RSA-2048, with the private key that corresponds to the public key stored in eFUSE memory. It is stored Little-Endian.

3.4 EC Runtime Binary Image

The EC Runtime FW Binary Image contains two contiguous components: the first is the firmware image that is loaded into SRAM and the second is the 256-byte signature that immediately follows the SRAM data. The Firmware Image is stored on the same SPI Flash as the Header. The Firmware image must start on a 64-byte boundary in the SPI Flash, and consists of an integral number of 64-byte blocks. If the firmware image does not end on a 64-byte boundary, it must be padded with zeros.

The Load Sequence configures the SPI Controller for a read operation as determined by the Flash Read Command field of the Header (as defined by Table 2 Flash Read Command Options).

After the image is read into SRAM, the Load Sequence calculates SHA-256 hash of the entire image.

The EC Firmware Binary Image signature is decrypted using the RSA Public Key 2 (modulus and exponent) contained in the Header. The EC Firmware Binary Image is validated by decrypting the 256-byte Signature located after the SRAM image in the SPI Flash and verifying that the calculated hash and the hash that was encrypted in the Signature match.

3.5 Runtime FW Digital Signature – K2

The Runtime FW Digital Signature is a DER encoded PKCS#1 v1.5 digital signature. The signature comprises a 256-bit SHA256 hash of the EC Runtime FW Binary Image, encrypted using RSA-2048, with the private key that corresponds to the public key stored in the RSA Public Key fields of the FW Image Header. It is stored Little-Endian.

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4.0 LOAD FAILURES

If the ROM code fails to load a valid EC Runtime Binary Image for any reason, the ROM code exits. The ROM code writes to the ROM Event Log portion of SRAM and resets the part, using the Watchdog Timer.

4.1 ROM Event Log

A log of ROM processing from POR/Reset will be stored in the last 16 bytes of data SRAM space (0x11FFF0 - 0x11FFFF). The ROM will log strap detection and various states of the SPI read and verification process.

The ROM Event Log format is defined in the following table:

TABLE 4-1: ROM EVENT LOG FORMAT

Byte	Bits	Description
0x11FFF0	[7:4]	Current number of WDT resets
	[3]	Private SPI (SPI-1) Chip Select 0 pin sampled 0b = Not stable high 1b = High for 200us sample period
	[2]	SPI Voltage Rail (SPI-0 CS0 pin) 0b = SPI Voltage Rail down (low) 1b = SPI Voltage Rail Up (high for 500 us)
	[1]	RSMRST# pin state 0b = RSMRST# inactive (High) 1b = RSMRST# active (Low for 200us)
	[0]	1 = Halt due to Watch Dog Timer resetting the system 15 times.
0x11FFF1	[7:0]	Reserved
0x11FFF2	[7:0]	Bits[3:0] = SPI0 Tag 0 Read attempts Bit[4] = Good Tag has bit[23]==1 use CS1
0x11FFF3	[7:0]	SPI0 CS0/CS1 Tag 0 State see Table 4-2, "Log State Values"
0x11FFF4	[7:0]	Bits[3:0] = SPI0 Tag 1 Read attempts Bit[4] = Good Tag has bit[23]==1 use CS1
0x11FFF5	[7:0]	SPI0 CS0/CS1 Tag 1 State see Table 4-2, "Log State Values"
0x11FFF6	[7:0]	Bits[3:0] = SPI1 Tag 0 Read attempts Bit[4] = Good Tag has bit[23]==1 use CS1
0x11FFF7	[7:0]	SPI1 CS0/CS1 Tag 0 State see Table 4-2, "Log State Values"
0x11FFF8	[7:0]	Bits[3:0] = SPI1 Tag 1 Read attempts Bit[4] = Good Tag has bit[23]==1 use CS1
0x11FFF9	[7:0]	SPI1 CS0/CS1 Tag1 State see Table 4-2, "Log State Values"
0x11FFFA	[7:0]	Reserved
0x11FFFB	[7:0]	Reserved
0x11FFFC	[7:0]	Reserved
0x11FFFD	[7:0]	Reserved
0x11FFFE	[7:0]	Reserved
0x11FFFF	[7:0]	Reserved

TABLE 4-2: LOG STATE VALUES

Value	Description
0x00	Device (SPIx TAGy) Loader state machine not entered
0x01	SPI Read of Header and RSA signature successful
0x02	Header Title OK (‘SMSC’ in first 4 bytes)
0x03	Header RSA Signature Decryption successful
0x04	Header RSA Signature Authentication OK
0x05	Header Payload Length OK
0x06	Header Payload Load Address Aligned on 64-byte Boundary OK
0x07	Header Content Check OK
0x08	SPI Read of Payload RSA signature successful
0x09	Payload RSA Signature Decryption successful
0x0A	SPI Read of Payload successful
0x0B	Payload RSA signature Authentication OK
0x0C	ROM Launching Payload
0x0D – 0xFF	Unused

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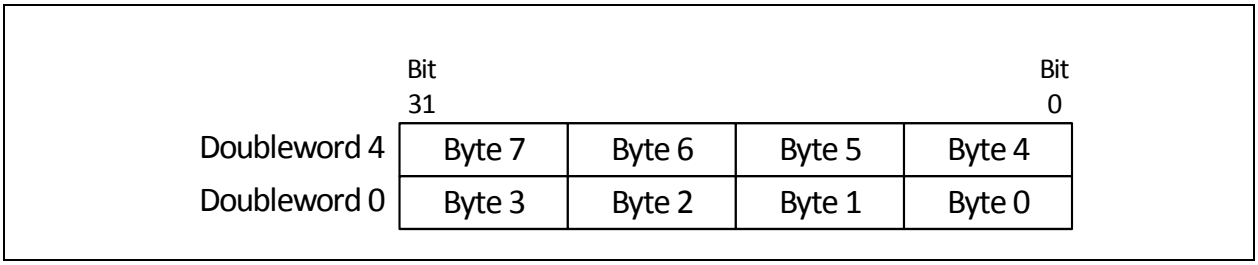
5.0 SHA-256 HASHING AND DATA ORDER

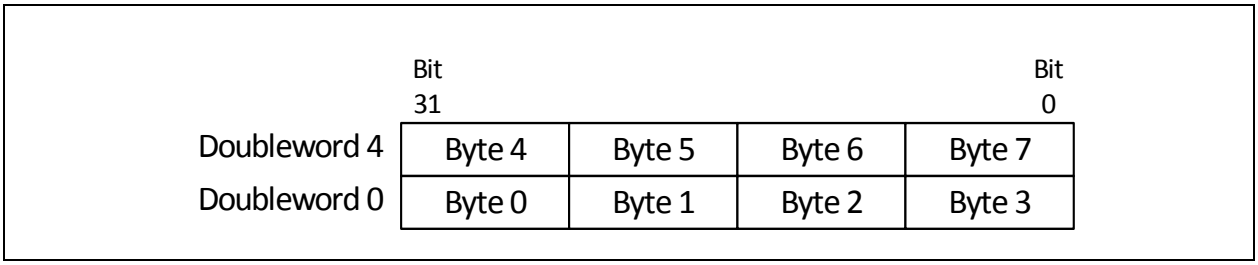
The CEC1302, along with PCs based on the Intel x86 architecture, employ a “Little-Endian” byte order: memory addresses bytes, and within a 32-bit doubleword, the least significant bit. The following figure illustrates Little-Endian byte order:

FIGURE 5-1: LITTLE ENDIAN BYTE ORDER



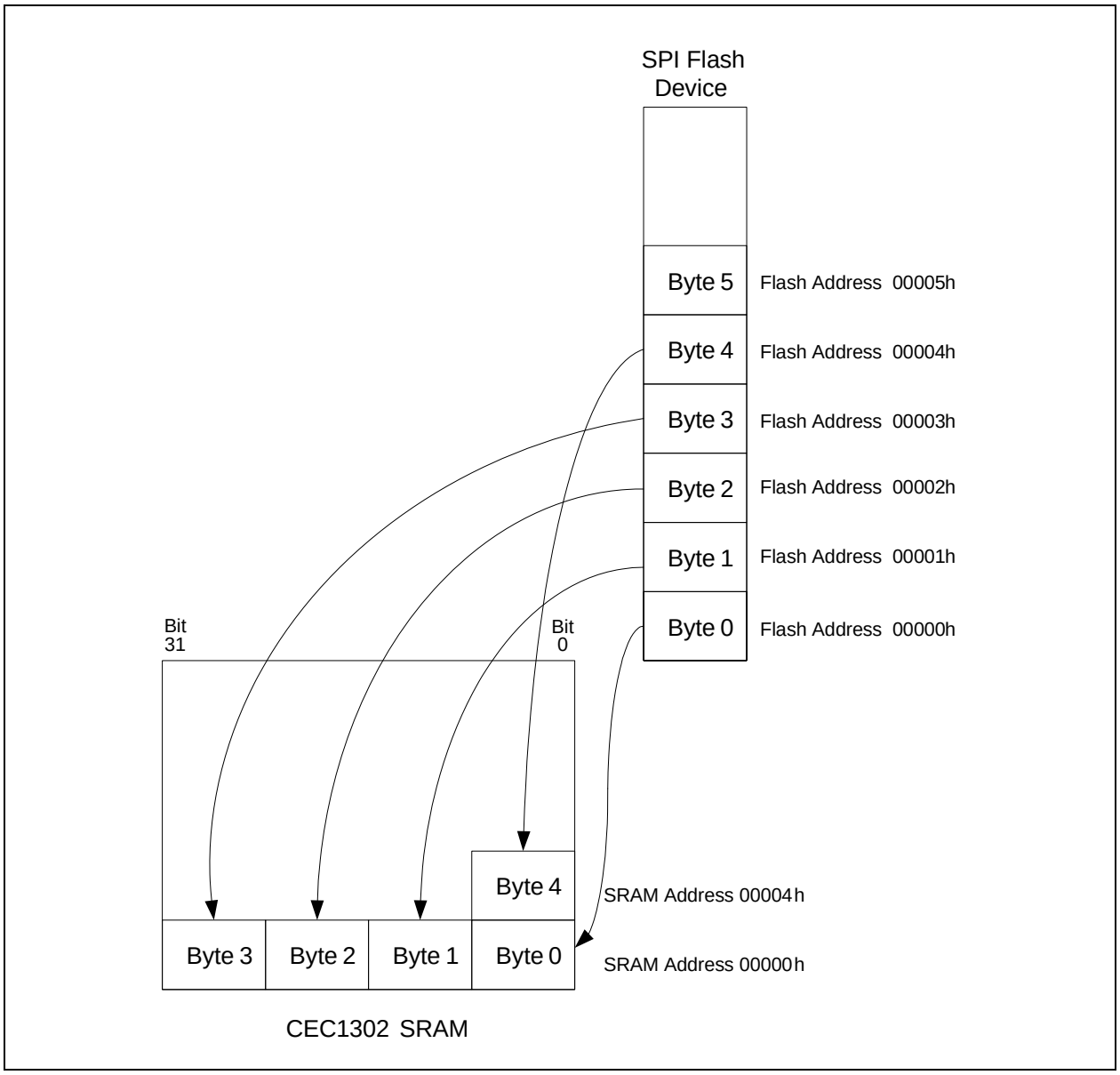
Other systems, in particular networking systems, use “Big Endian” byte order, in which byte 0 within a 32-bit doubleword addresses the most significant byte of the word and byte 3 addresses the least significant byte:

FIGURE 5-2: BIG ENDIAN BYTE ORDER



The boot ROM loads data from a byte-oriented SPI Flash into SRAM. The ROM firmware moves sequential bytes from the SPI Flash into the CEC1302 SRAM in a Little-Endian order, as shown in the following figure:

FIGURE 5-3: MAPPING SPI DATA TO SRAM



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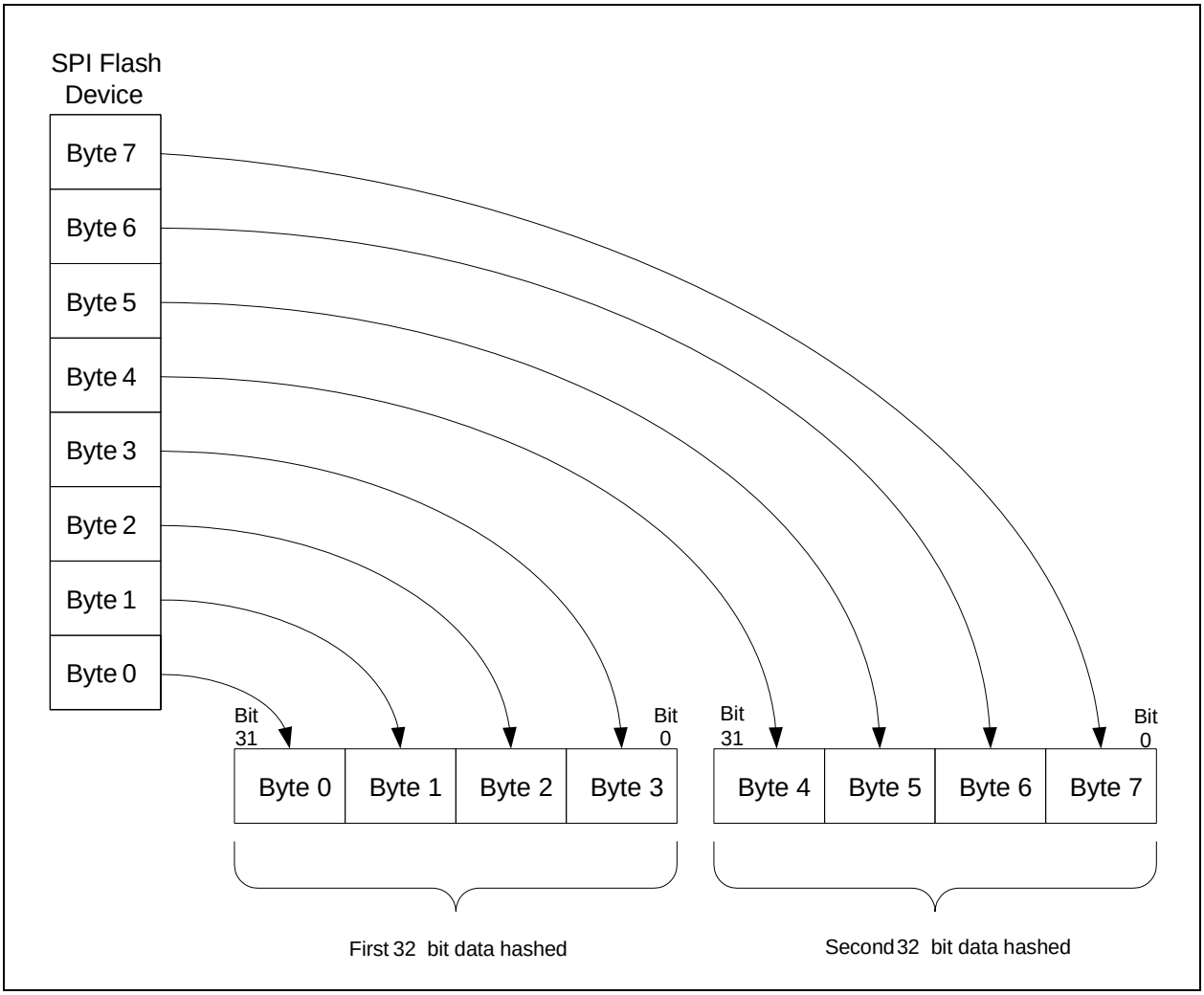
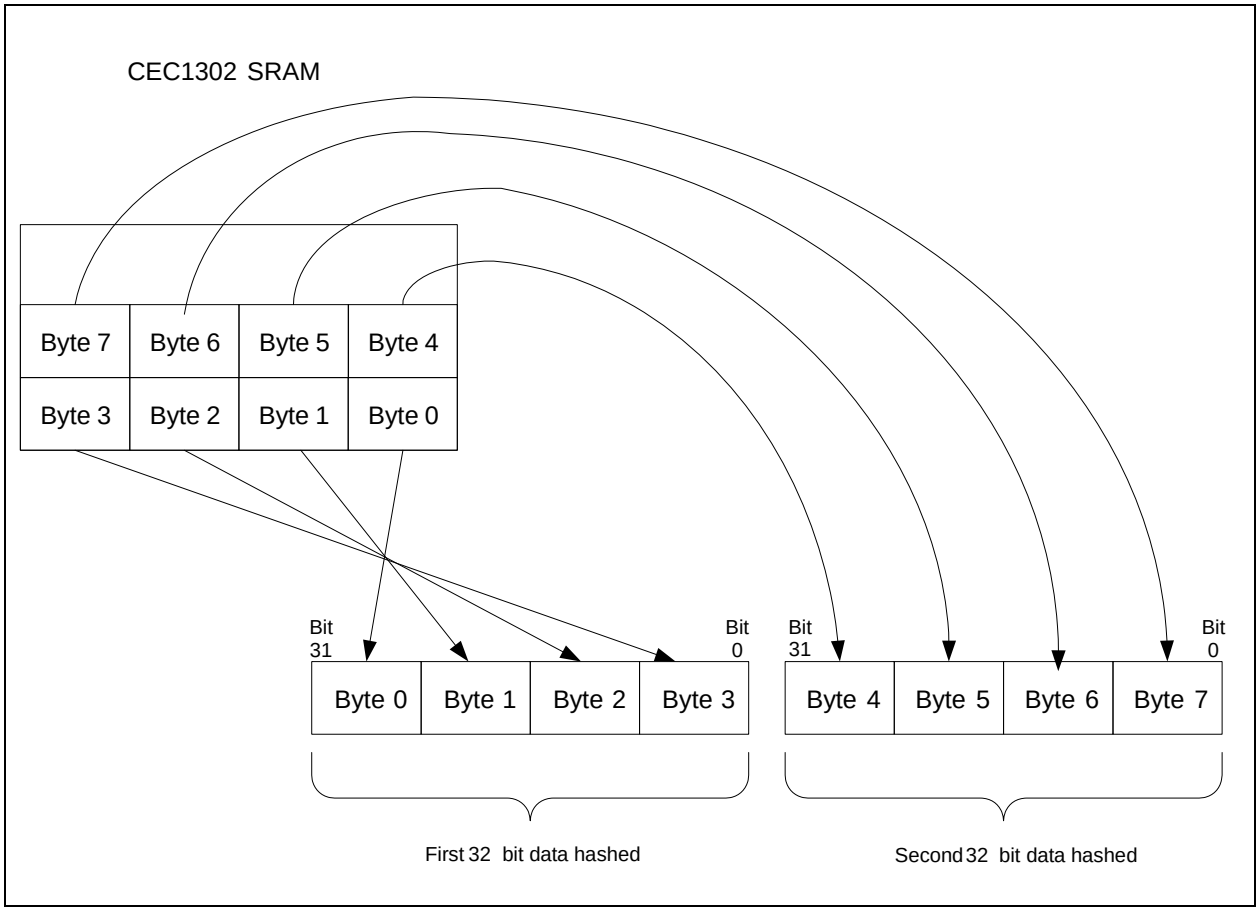
Because most network-oriented software tools that deal with SHA hashing are Big-Endian, most of the tools hash data that went into the SPI Flash device in the order shown in the following figure:

FIGURE 5-4: NETWORK-ORIENTED HASH



In order to be compatible with software tools that are used to hash the image that is loaded into the Flash, the CEC1302 automatically reverses the byte order of data in SRAM when sending it to the Hash Engine:

FIGURE 5-5: MAPPING FROM SRAM TO HASH



See the documents referenced in **Section 6.0 "ROM Runtime API"** for information on the APIs that are used for SHA-256.

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6.0 ROM RUNTIME API

The CEC1302 ROM provides a number of application programming interfaces to assist the EC application firmware. The APIs that are provided for the device fall into the following categories:

- SPI Access
- Security
- Miscellaneous Functions

The full descriptions of these APIs are contained in these referenced documents:

- CEC1302 Crypto API User's Guide
- CEC1302 Peripheral API User's Guide.

Sample code is contained in the following document:

- CEC1302 CLIB/PLIB Releases

APPENDIX A: ADDENDUM REVISION HISTORY

TABLE A-1: REVISION HISTORY

Revision	Section/Figure/Entry	Correction
DS00002235A (07-14-16)	Document Release	

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